


Notes:

1. All dimensions are in mm. Angles in degrees.
2. Coplanarity applies to the exposed pad as well as the terminals.
Coplanarity shall not exceed 0.08 mm.
3. Warpage shall not exceed 0.10 mm.
4. Refer JEDEC MO-241
5. Thermal pad soldering area (mesh stencil design is recommended)

 PERICOM [®] Enabling Serial Connectivity	DATE: 09/14/10
DESCRIPTION: 24-contact, Thin Quad Flat No-Lead (TQFN)	
PACKAGE CODE: ZK (ZK24)	
DOCUMENT CONTROL #: PD-2043	REVISION: B